

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
2	Inner Layer 1	0.035mm	ED Base Copper			
		0.360mm	Core IPC-4101/21	4,1	0,02	FR-4.0
3	Inner Layer 2	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
4	Inner Layer 3	0.035mm	ED Base Copper			
		0.360mm	Core IPC-4101/21	4,1	0,02	FR-4.0
5	Inner Layer 4	0.035mm	ED Base Copper			
		0.220mm	Prepreg IPC-4101/21	3,9	0,02	FR-4.0
6	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
Total thickness: 1.620mm						

Würth Elektronik GmbH & Co. KG
Circuit Board Technology

notes:
Final copper thickness according to IPC-6012
Please regard to our sectional design rules:
► www.we-online.com

BASIC6_ML6_1,62_35_V2.12			
PCB Thickness Tolerance: ± 10%			
customer		created	
pcb name		approved	
engineer		format	A4, landscape
date			
Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen			

